IRL510

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V) R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_q (Max.) (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.54

100

6.1

2.6

3.3

Single

 $V_{GS} = 5.0 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	ТО-220АВ
Lead (Pb)-free	IRL510PbF
Lead (Pb)-free and halogen-free	IRL510PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, un	less otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	100	- V	
Gate-source voltage			V _{GS}	± 10		
Continuous drain current	V at EV	T _C = 25 °C	I _D	5.6		
	VGS at 5 V	V_{GS} at 5 V $T_C = 100 \degree C$		4.0	А	
Pulsed drain current ^a			I _{DM}	18		
Linear derating factor				0.29	W/°C	
Single pulse avalanche energy ^b			E _{AS}	100	mJ	
Repetitive avalanche current ^a			I _{AR}	5.6	А	
Repetitive avalanche energy ^a			E _{AR}	4.3	mJ	
Maximum power dissipation	ower dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			43	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	- °C	
Soldering recommendations (peak temperature) ^d	For 10 s			300 ^d		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25$ V, starting $T_J = 25$ °C, L = 4.8 mH, $R_g = 25 \Omega$, $I_{AS} = 5.6$ A (see fig. 12)

c. $I_{SD} \le 5.6$ A, dI/dt ≤ 75 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	3.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•			
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-source leakage	I _{GSS}	N	V _{GS} = ± 10 V	-	-	± 100	nA
Zara gata valtaga drain aurrant	le e e	V _{DS} =	100 V, V _{GS} = 0 V	-	-	25	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 80 V,	V_{GS} = 0 V, T_J = 150 °C	-	-	250	
Drain-source on-state resistance	P	$V_{GS} = 5.0 V$	$I_D = 3.4 \text{ Ab}$	-	-	0.54	Ω
	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D = 2.8 A ^b	-	-	0.76	52
Forward transconductance	g fs	V _{DS} =	: 50 V, I _D = 3.4 A ^b	1.9	-	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{CS} = 0 V_{c}$	-	250	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz see fig 5		-	pF		
Reverse transfer capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	1
Total gate charge	Qg			-	-	6.1	
Gate-source charge	Q _{gs}	$V_{GS} = 5.0 V$	I _D = 5.6 A, V _{DS} = 80 V see fig. 6 and 13 ^b	-	-	2.6	nC
Gate-drain charge	Q _{gd}			-	-	3.3	
Turn-on delay time	t _{d(on)}			-	9.3	-	
Rise time	t _r		= 50 V, I _D = 5.6 A 12 Ω, R _D = 8.4 Ω	-	47	-	
Turn-off delay time	t _{d(off)}	n _g =	see fig. 10 ^b	-	16	-	ns
Fall time	t _f			-	18	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal source inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	5.6	Α
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	18	
Body diode voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 5.6 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T.1 = 2	25 °C, I _F = 5.6 A.	-	110	130	ns
Body diode reverse recovery charge	Q _{rr}	dl/	25 °C, I _F = 5.6 A, dt = 100 A/μs ^b	-	0.50	0.65	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turi	n-on is doi	ninated t	by Ls and	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

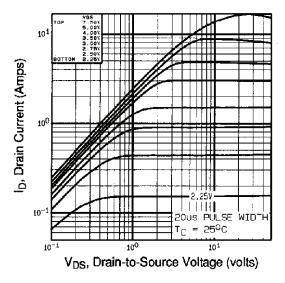


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

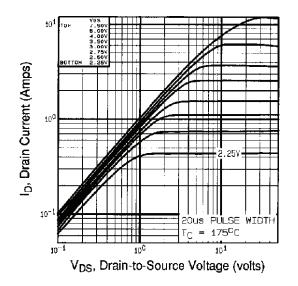
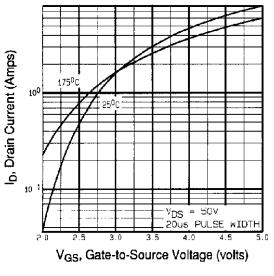


Fig. 2 - Typical Output Characteristics, T_C = 175 °C





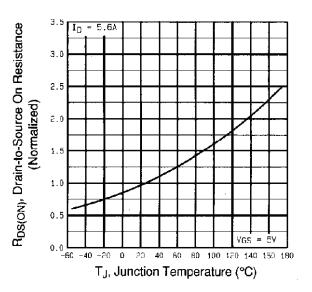


Fig. 4 - Normalized On-Resistance vs. Temperature



IRL510

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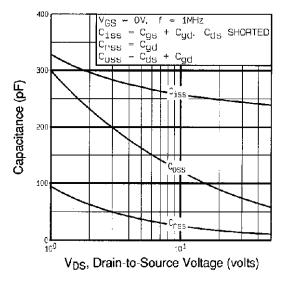


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

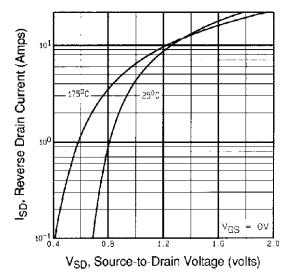


Fig. 7 - Typical Source-Drain Diode Forward Voltage

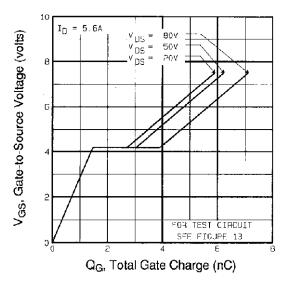


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

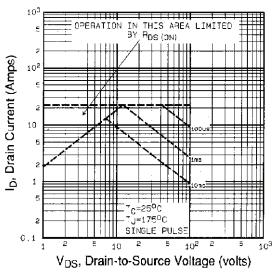


Fig. 8 - Maximum Safe Operating Area



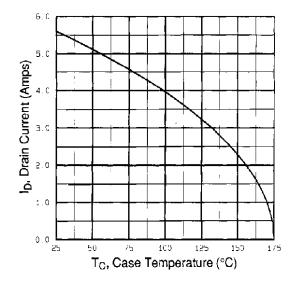


Fig. 9 - Maximum Drain Current vs. Case Temperature

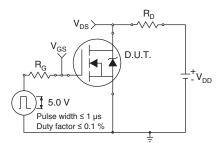


Fig. 10a - Switching Time Test Circuit

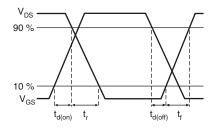


Fig. 10b - Switching Time Waveforms

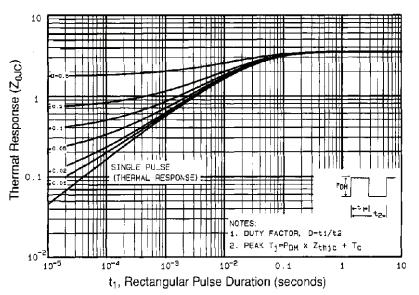


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



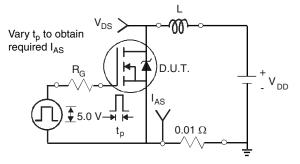


Fig. 12a - Unclamped Inductive Test Circuit

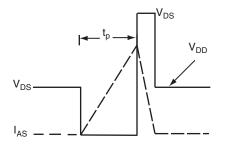


Fig. 12b - Unclamped Inductive Waveforms

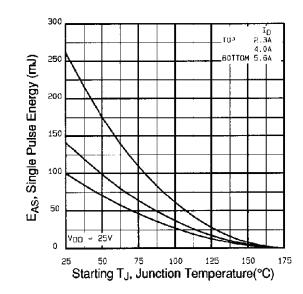


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

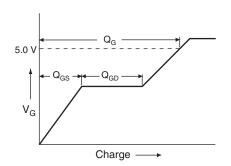


Fig. 13a - Basic Gate Charge Waveform

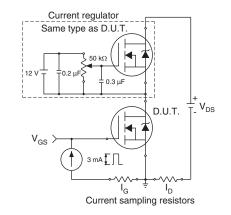


Fig. 13b - Gate Charge Test Circuit

6

Document Number: 91297

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IRL510

Peak Diode Recovery dv/dt Test Circuit

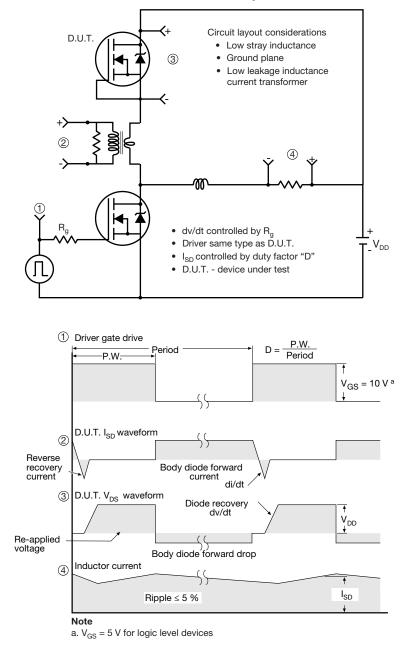


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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